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#### DATA SHEET www.onsemi.com

### Subminiature Plastic Infrared Emitting Diode

### **QEB363**

#### Features

- T-3/4 (2 mm) Surface Mount Package
- Lead Form Options: Gullwing, Yoke, Z-Bend
- Narrow Emission Angle, 24°
- Wavelength = 940 nm, GaAs
- Clear Water Lens
- Matched Photosensor: QSB363
- High Radiant Intensity
- This is a Pb–Free and Halide Free Device

#### MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
T <sub>OPR</sub>	Operating Temperature	-40 to +100	°C
T <sub>STG</sub>	Storage Temperature	-40 to +100	°C
T <sub>SOL-I</sub>	Soldering Temperature (Iron) (Notes 2, 3, 4)	240 for 5 s	°C
T <sub>SOL-F</sub>	Soldering Temperature (Flow) (Notes 2, 3)	260 for 10 s	°C
١ <sub>F</sub>	Continuous Forward Current	50	mA
V <sub>R</sub>	Reverse Voltage	5	V
PD	Power Dissipation (Note 1)	100	mW

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. NOTES:

- 1. Derate power dissipation linearly 1.33 mW/°C above 25°C.
- 2. RMA flux is recommended.
- 3. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 4. Soldering iron 1/16" (1.6 mm) minimum from housing.



T-3/4, 2.50 × 2.00 CASE 100CA



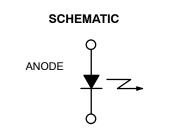
T-3/4, 2.50 × 2.00 CASE 100CV



T-3/4, 2.50 × 2.00 CASE 100CW



T-3/4 2.50 × 2.00 CASE 100ED



#### ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

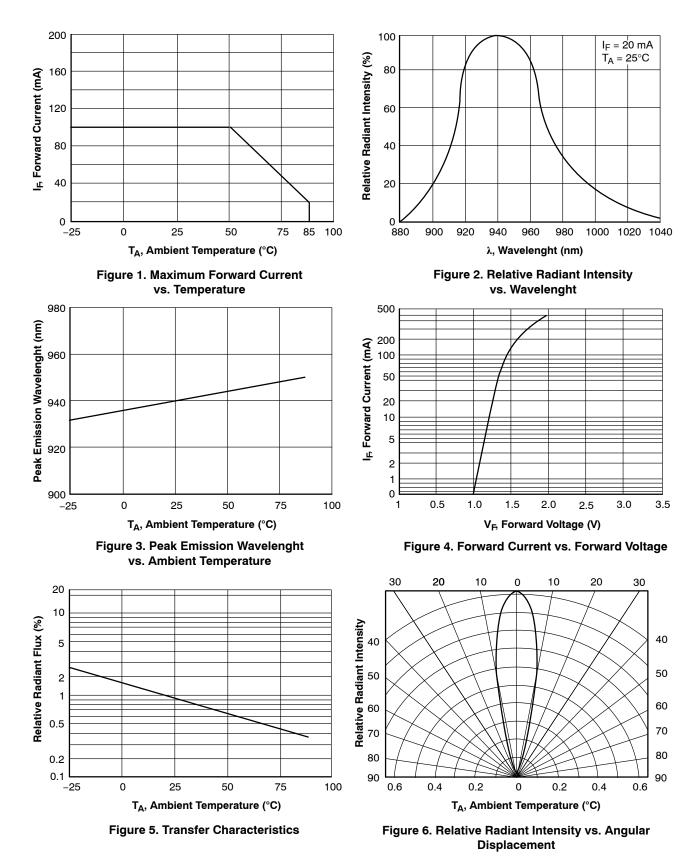
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
λP	Peak Emission Wavelength	I <sub>F</sub> = 100 mA	-	940	-	nm
Θ	Emission Angle	I <sub>F</sub> = 100 mA	-	±12	-	0
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 100 mA, t <sub>p</sub> = 20 ms	-	-	1.6	V
I <sub>R</sub>	Reverse Current	V <sub>R</sub> = 5 V	-	-	100	μΑ
Ι <sub>e</sub>	Radiant Intensity	I <sub>F</sub> = 100 mA, t <sub>p</sub> = 20 ms	8	-	-	mW/sr
t <sub>r</sub>	Rise Time	I <sub>F</sub> = 100 mA	-	1	-	μs
t <sub>f</sub>	Fall Time	t <sub>p</sub> = 20 ms	-	1	-	μs

**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

### **QEB363**

#### **TYPICAL PERFORMANCE CURVES**



#### **ORDERING INFORMATION**

Part Number	Package	Shipping <sup>†</sup>
QEB363	T-3/4, 2.50 × 2.00 (Case 100CA) (Pb-Free)	1000 Units / Bulk
QEB363GR	T–3/4, 2.50 × 2.00 (Case 100CV) (Pb–Free)	1000 / Tape & Reel
QEB363YR	T–3/4, 2.50 × 2.00 (Case 100ED) (Pb–Free)	1000 / Tape & Reel
QEB363ZR	T−3/4, 2.50 × 2.00 (Case 100CW) (Pb−Free)	1000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

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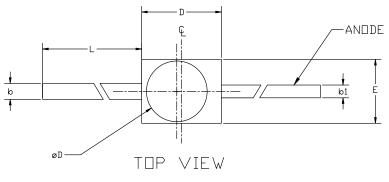
T-3/4 2.50x2.00 CASE 100CA ISSUE A

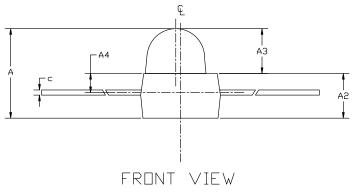
DATE 14 SEP 2023

**ONSEM** 

NDTES:

- 1. CONTROLLING DIMENSIONS: MILLIMETERS
- 2. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- 3. 2MM LED





	MILLIMETERS		
	MIN.	NDM.	MAX.
A	2,50	2.70	2,90
A2	1.30	1.40	1.50
A3	1.30	1.40	1.50
A4		0.60 REF	
b	0.45	0.55	0.65
b1	0.35	0.45	0.55
С	0.10	0.15	0.25
D	2,30	2,50	2.70
E	1.80	2.00	2.20
L	7.00		
øD	1.70	1.90	2.10

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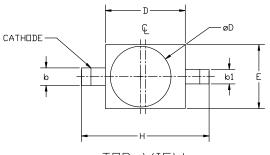
**T-3/4, 2.50x2.00** CASE 100CV ISSUE A

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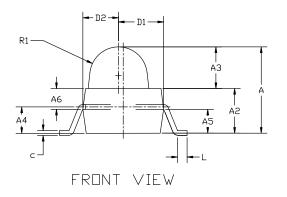
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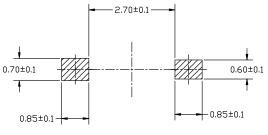
- 1. CONTROLLING DIMENSIONS: MILLIMETERS
- 2. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- 3. 2MM GULLWING LED







	MILLIMETERS		
DIM	MIN.	NDM.	MAX.
А	2.50	2.70	2,90
A2	1.30	1.40	1.50
A3	1.20	1.30	1.40
A4	0.75	0.85	0.95
A5	0.65	0.75	0,85
A6	0.55	0.65	0.75
b	0.45	0.55	0.65
b1	0.35	0.45	0.55
С	0.10	0.15	0.20
D	2.30	2.50	2,70
D1	1.20	1.40	1.60
D2	0.90	1.10	1.30
E	1.80	2.00	2.20
Н	3.80	4.00	4.20
L	0.20	0.30	0.40
øD	1.70	1.90	2.10
R1	0.70	0.80	0.90



#### LAND PATTERN RECOMMENDATION

\* For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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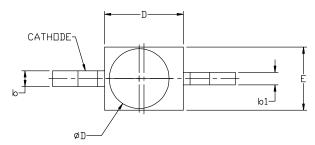
T-3/4, 2.50x2.00 CASE 100CW ISSUE A

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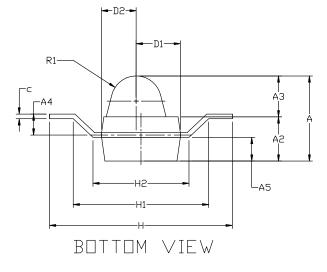
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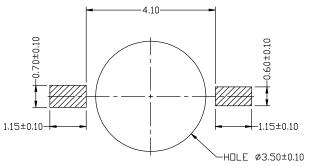
- 1. CONTROLLING DIMENSIONS: MILLIMETERS 2. DIMENSIONS DO NOT INCLUDE MOLD FLASH
- DR BURRS.
- 3. 2MM ZBEND LED.







DIM	М	ILLIMETER	2?
MIU	MIN.	N□M.	MAX.
A	2.500	2.700	2.900
A2	1.300	1.400	1.500
A3	1.200	1.300	1.400
A4	0.550	0.650	0.750
A5	0.650	0.750	0.850
b	0.450	0.550	0.650
b1	0.350	0.450	0.550
С	0.100	0.150	0.200
D	2.300	2.500	2.700
D1	1.200	1.400	1.600
D2	0,900	1.100	1.300
E	1.800	5.000	2.200
н	5.600	5.800	6.000
H1	4,100	4.300	4.500
H2	2,850	3.050	3.250
ØD	1.700	1.900	2.100
R1	0.700	0.800	0.900



RECOMMENDED MOUNTING FOOTPRINT\* \*FOR ADDITIONAL INFORMATION ON OUR P6-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

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#### MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



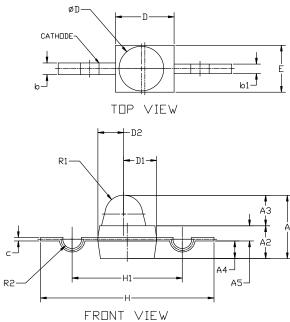
T-3/4 2.50x2.00 CASE 100ED ISSUE O

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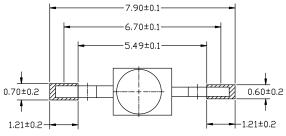
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NDTES:

- 1. CONTROLLING DIMENSIONS: MILLIMETERS
- 2. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- 3. 2MM YOKE LED



	MILLIMETERS		
DIM	MIN.	NDM.	MAX.
Α	2.50	2.70	2,90
A2	1.30	1.40	1.50
A3	1.20	1.30	1,40
A4	0.65	0.75	0.85
b	0.45	0.55	0.65
b1	0.35	0.45	0.55
С	0.10	0.15	0.20
D	2.30	2.50	2.70
D1	1.20	1.40	1.60
D2	0.90	1.10	1.30
E	1.80	2.00	2.20
Н	7.20	7.40	7.60
H1	4.50	4.70	4.90
ØD	1.70	1.90	2.10
R1	0.70	0.80	0.90
R2	0.30	0.40	0.50



#### RECOMMENDED Mounting footprint

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